

L Number	Hits	Search Text	DB	Time stamp
1	1196	microelectronic with pack\$4	USPAT	2004/08/24 11:14
2	283	microelectronic with pack\$4 with substrate	USPAT	2004/08/24 11:15
3	106	(microelectronic with pack\$4 with substrate) and (recess\$4 or opening\$2)	USPAT	2004/08/24 11:29
4	17	(microelectronic with pack\$4 with substrate) and (recess\$4 or opening\$2) and tessera	USPAT	2004/08/24 12:13
5	89	((microelectronic with pack\$4 with substrate) and (recess\$4 or opening\$2)) not ((microelectronic with pack\$4 with substrate) and (recess\$4 or opening\$2) and tessera)	USPAT	2004/08/24 12:14
6	24	((((microelectronic with pack\$4 with substrate) and (recess\$4 or opening\$2)) not ((microelectronic with pack\$4 with substrate) and (recess\$4 or opening\$2) and tessera)) and (flip adj chip\$4)	USPAT	2004/08/24 12:14